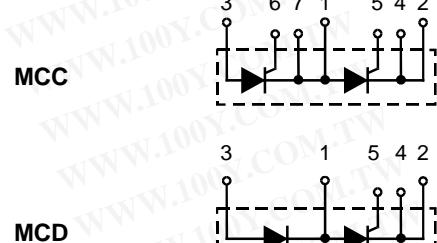
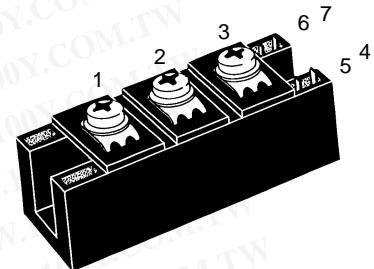


# Thyristor Modules

## Thyristor/Diode Modules

$I_{TRMS} = 2 \times 300 \text{ A}$   
 $I_{TAVM} = 2 \times 130 \text{ A}$   
 $V_{RRM} = 800-1800 \text{ V}$

$V_{RSM}$ $V_{DSM}$	$V_{RRM}$ $V_{DRM}$	Type	
V	V	Version 1	Version 1
900	800	MCC 132-08io1	MCD 132-08io1
1300	1200	MCC 132-12io1	MCD 132-12io1
1500	1400	MCC 132-14io1	MCD 132-14io1
1700	1600	MCC 132-16io1	MCD 132-16io1
1900	1800	MCC 132-18io1	MCD 132-18io1



Symbol	Test Conditions	Maximum Ratings	
$I_{TRMS}, I_{FRMS}$	$T_{VJ} = T_{VJM}$	300	A
$I_{TAVM}, I_{FAVM}$	$T_c = 85^\circ\text{C}; 180^\circ \text{ sine}$	130	A
$I_{TSM}, I_{FSM}$	$T_{VJ} = 45^\circ\text{C}; V_R = 0$ $t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	4750	A
	$T_{VJ} = T_{VJM}$ $V_R = 0$ $t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	5080	A
$\int i^2 dt$	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0$ $t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	4230	A
	$T_{VJ} = T_{VJM}$ $V_R = 0$ $t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	4530	A
$(di/dt)_{cr}$	$T_{VJ} = T_{VJM}$ $f = 50 \text{ Hz}, t_p = 200 \mu\text{s}$ $V_D = 2/3 V_{DRM}$ $I_G = 0.5 \text{ A}$ $di_G/dt = 0.5 \text{ A}/\mu\text{s}$	113 000	$\text{A}^2\text{s}$
	repetitive, $I_T = 500 \text{ A}$	150	$\text{A}/\mu\text{s}$
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}$ $R_{GK} = \infty$ ; method 1 (linear voltage rise)	1000	$\text{V}/\mu\text{s}$
$P_{GM}$	$T_{VJ} = T_{VJM}$ $I_T = I_{TAVM}$	120	W
	$t_p = 30 \mu\text{s}$	60	W
	$t_p = 500 \mu\text{s}$	8	W
$V_{RGM}$		10	V
$T_{VJ}$		-40...+125	$^\circ\text{C}$
$T_{VJM}$		125	$^\circ\text{C}$
$T_{stg}$		-40...+125	$^\circ\text{C}$
$V_{ISOL}$	50/60 Hz, RMS	3000	$\text{V}\sim$
	$I_{ISOL} \leq 1 \text{ mA}$	3600	$\text{V}\sim$
$M_d$	Mounting torque (M6) Terminal connection torque (M6)	2.25-2.75/20-25 Nm/lb.in. 4.5-5.5/40-48 Nm/lb.in.	
<b>Weight</b>	Typical including screws	125	g

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.  
 IXYS reserves the right to change limits, test conditions and dimensions

### Features

- International standard package
- Direct copper bonded  $\text{Al}_2\text{O}_3$ -ceramic base plate
- Planar passivated chips
- Isolation voltage 3600 V $\sim$
- UL registered, E 72873
- Keyed gate/cathode twin pins

### Applications

- Motor control
- Power converter
- Heat and temperature control for industrial furnaces and chemical processes
- Lighting control
- Contactless switches

### Advantages

- Space and weight savings
- Simple mounting
- Improved temperature and power cycling
- Reduced protection circuits

Symbol	Test Conditions	Characteristic Values	
$I_{RRM}, I_{DRM}$	$T_{VJ} = T_{VJM}; V_R = V_{RRM}; V_D = V_{DRM}$	10	mA
$V_T, V_F$	$I_T, I_F = 300 \text{ A}; T_{VJ} = 25^\circ\text{C}$	1.36	V
$V_{TO}$	For power-loss calculations only ( $T_{VJ} = 125^\circ\text{C}$ )	0.8	V
$r_T$		1.5	$\text{m}\Omega$
$V_{GT}$	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	2.5	V
$I_{GT}$	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	150	mA
$V_{GD}$	$T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$	0.2	V
$I_{GD}$		10	mA
$I_L$	$T_{VJ} = 25^\circ\text{C}; t_p = 30 \mu\text{s}; V_D = 6 \text{ V}$ $I_G = 0.5 \text{ A}; di_G/dt = 0.5 \text{ A}/\mu\text{s}$	300	mA
$I_H$	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; R_{GK} = \infty$	200	mA
$t_{qd}$	$T_{VJ} = 25^\circ\text{C}; V_D = 1/2 V_{DRM}$ $I_G = 0.5 \text{ A}; di_G/dt = 0.5 \text{ A}/\mu\text{s}$	2	$\mu\text{s}$
$t_q$	$T_{VJ} = T_{VJM}; I_T = 160 \text{ A}, t_p = 200 \mu\text{s}; -di/dt = 10 \text{ A}/\mu\text{s}$ typ. $V_R = 100 \text{ V}; dv/dt = 20 \text{ V}/\mu\text{s}; V_D = 2/3 V_{DRM}$	150	$\mu\text{s}$
$Q_s$	$T_{VJ} = T_{VJM}; I_T, I_F = 300 \text{ A}, -di/dt = 50 \text{ A}/\mu\text{s}$	550	$\mu\text{C}$
$I_{RM}$		235	A
$R_{thJC}$	per thyristor/diode; DC current	0.23	K/W
	per module	0.115	K/W
$R_{thJK}$	per thyristor/diode; DC current	0.33	K/W
	per module	0.165	K/W
$d_s$	Creepage distance on surface	12.7	mm
$d_A$	Strike distance through air	9.6	mm
$a$	Maximum allowable acceleration	50	$\text{m/s}^2$

Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = yellow, cathode = red

Type **ZY 180L** (L = Left for pin pair 4/5)      UL 758, style 1385,

Type **ZY 180R** (R = right for pin pair 6/7)      CSA class 5851, guide 460-1-1

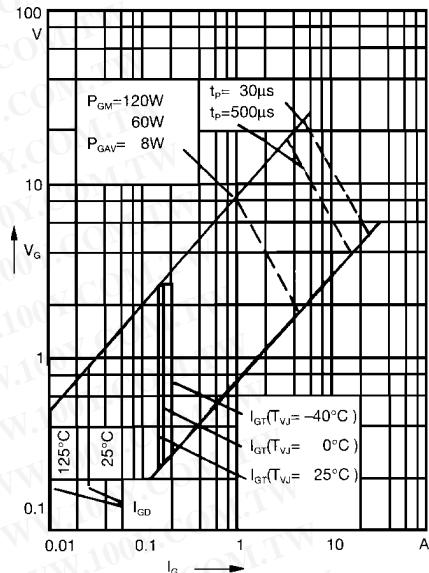


Fig. 1 Gate trigger characteristics

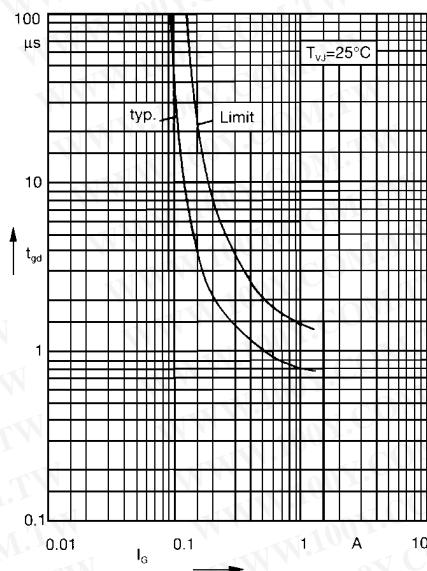
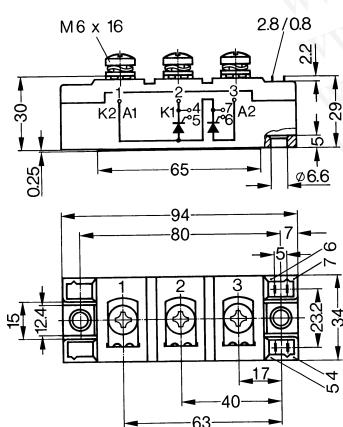


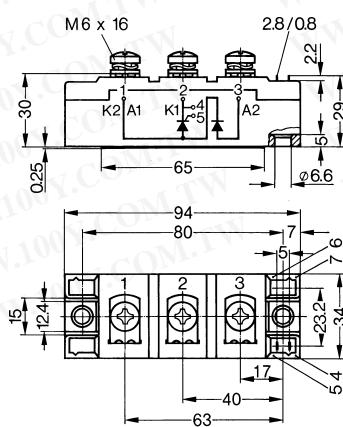
Fig. 2 Gate trigger delay time

#### Dimensions in mm (1 mm = 0.0394")

##### MCC



##### MCD



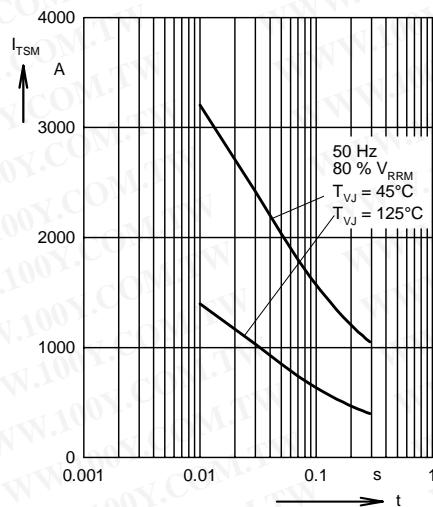


Fig. 3 Surge overload current  
 $I_{TSM}, I_{FSM}$ : Crest value, t: duration

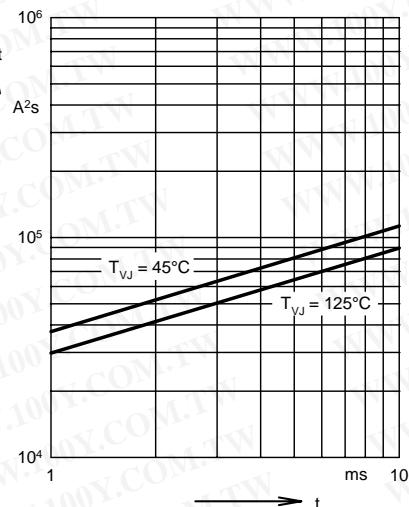


Fig. 4  $i^2t$  versus time (1-10 ms)

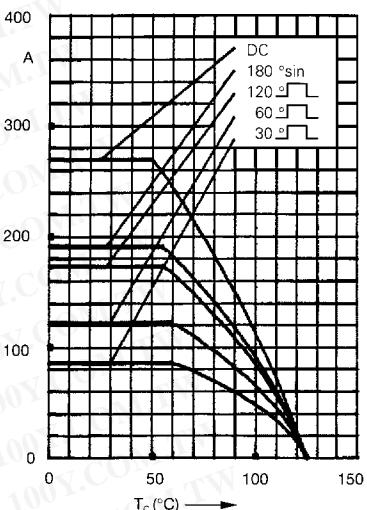


Fig. 4a Maximum forward current at case temperature

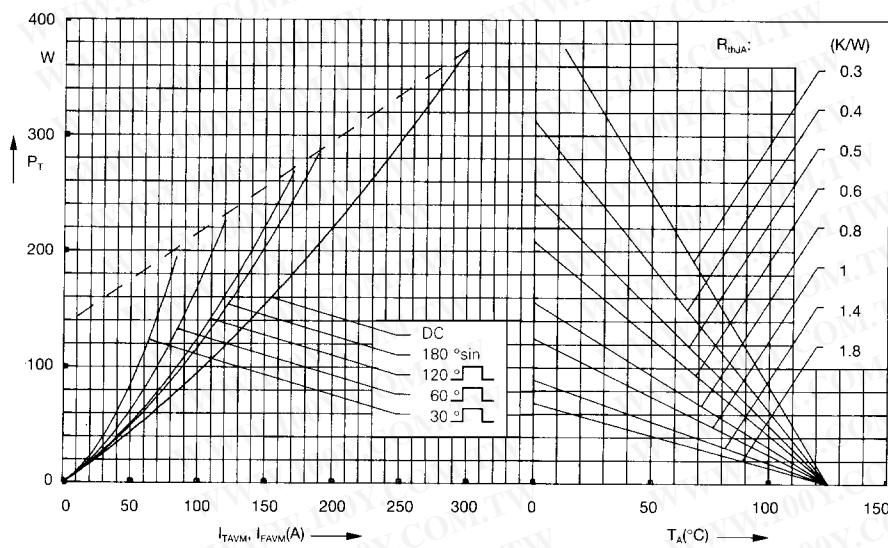


Fig. 5 Power dissipation versus on-state current and ambient temperature (per thyristor or diode)

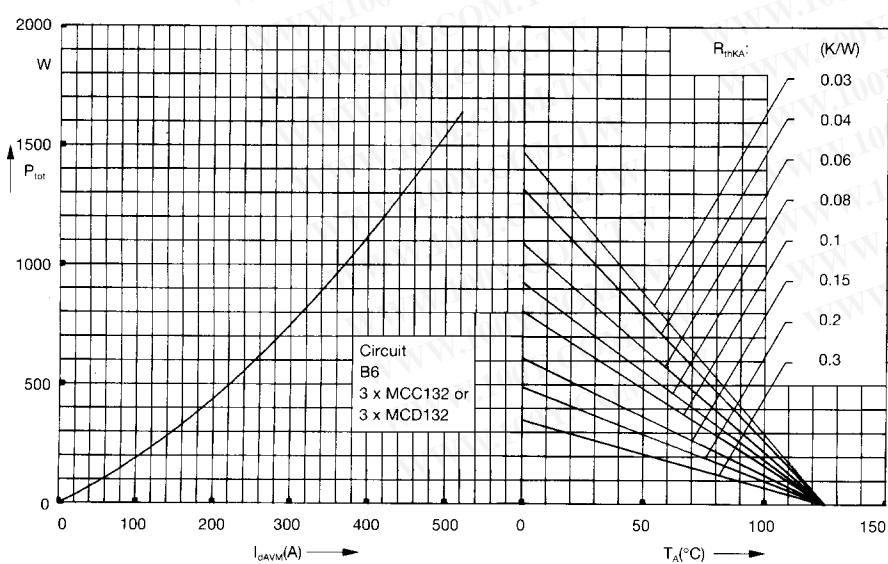


Fig. 6 Three phase rectifier bridge:  
 Power dissipation versus direct output current and ambient temperature

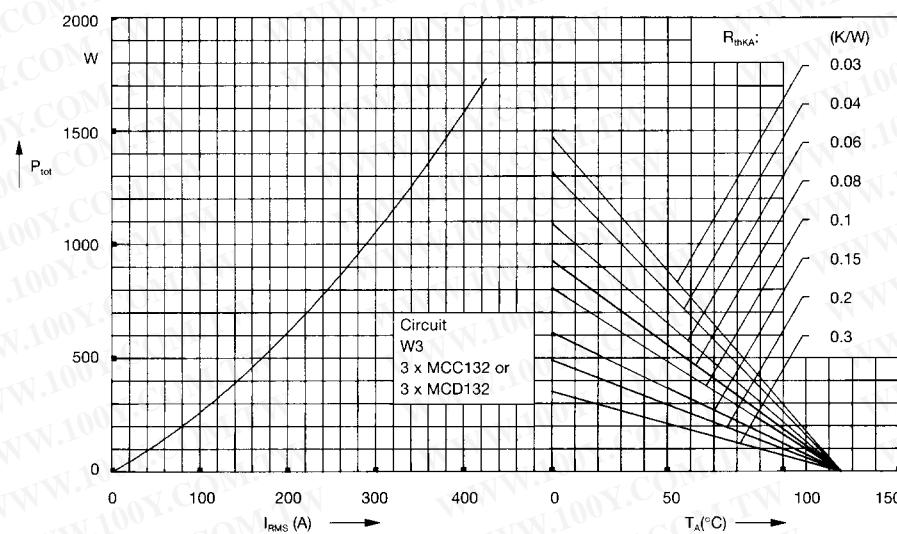


Fig. 7 Three phase AC-controller:  
 Power dissipation versus RMS output current and ambient temperature

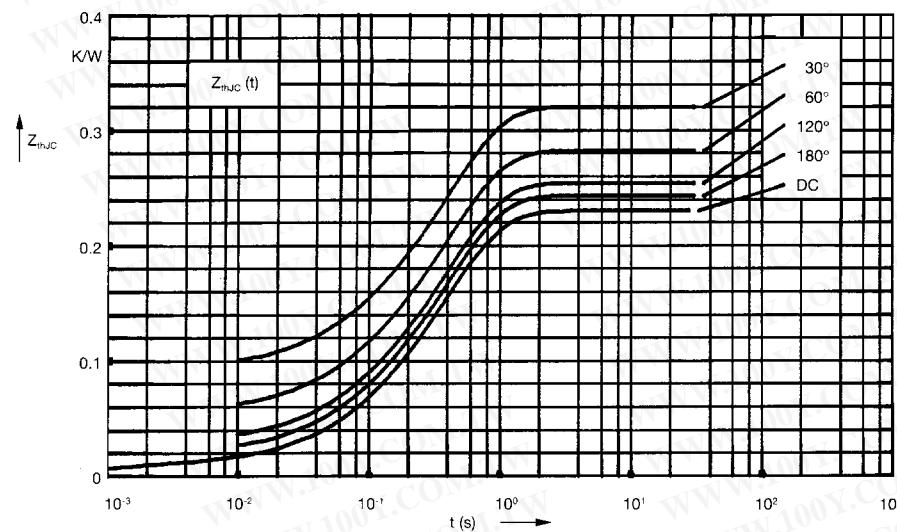


Fig. 8 Transient thermal impedance junction to case (per thyristor or diode)

$R_{thJC}$  for various conduction angles d:

d	$R_{thJC}$ (K/W)
DC	0.230
180°	0.244
120°	0.255
60°	0.283
30°	0.321

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0095	0.001
2	0.0175	0.065
3	0.203	0.4

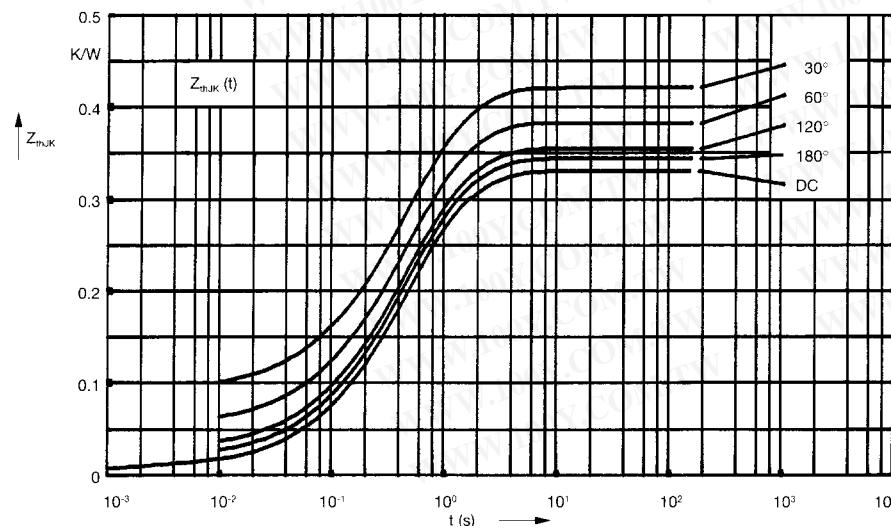


Fig. 9 Transient thermal impedance junction to heatsink (per thyristor or diode)

$R_{thJK}$  for various conduction angles d:

d	$R_{thJK}$ (K/W)
DC	0.330
180°	0.344
120°	0.355
60°	0.383
30°	0.421

Constants for  $Z_{thJK}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0095	0.001
2	0.0175	0.065
3	0.203	0.4
4	0.1	1.29